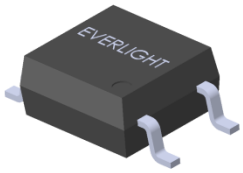
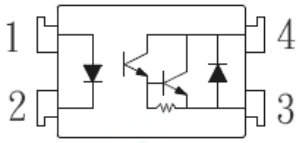
DATASHEET

4 PIN SOP HIGH VOLTAGE PHOTODARLINGTON PHOTOCOUPLER
EL452-G Series



Schematic



Pin Configuration
1. Anode
2. Cathode
3. Emitter
4. Collector

Features:

- •Halogens free(Br < 900 ppm, Cl < 900 ppm, Br+Cl < 1500 ppm)
- High collect-Emitter voltage (V_{CEO} = 350V)
- Current transfer ratio
  (CTR: Min. 1000% at I_F =1mA ,V_{CE} =2V)
- High isolation voltage between input and output
  (Viso=3750 V rms)
- Compact 4 Pin SOP with a 2.0 mm profile
- Pb free and RoHS compliant.
- Compliance with EU REACH.
- UL & CUL approved
- VDE approved
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved
- CQC approved

Description

The EL452-G contains an infrared emitting diode, optically coupled to a high voltage darlington phototransistor.

It is packaged in a 4-pin small outline SMD package.

Applications

- Telephone set, telephone exchangers
- Sequence controllers
- System appliances, measuring instruments
- Signal transmission between circuits of different potentials and impedance

Absolute Maximum Ratings (Ta=25℃)

Parameter		Symbol	Rating	Unit
Input	Forward current	I_F	60	mA
	Peak forward current (t = 10μs)	I_{FM}	1	A
	Power dissipation	P_D	100	mW
Output	Power dissipation	P_C	150	mW
	Collector current	I_C	150	mA
	Collector-Emitter voltage	V_{CEO}	350	V
	Emitter-Collector voltage	V_{ECO}	0.1	V
Total power dissipation		P_{TOT}	170	mW
Isolation voltage *1		V_{ISO}	3750	V rms
Operating temperature		T_{OPR}	-55~+110	°C
Storage temperature		T_{STG}	-55~+125	°C
Soldering Temperature*2		T_{SOL}	260	°C

Notes:

*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1 & 2 are shorted together, and pins 3 & 4 are shorted together.

*2 For 10 seconds

Electro-Optical Characteristics (Ta=25℃ unless specified otherwise)

Input

Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
Forward Voltage	V_F	-	1.2	1.4	V	I_F = 10mA
Reverse Current	I_R	-	-	10	μA	V_R = 4V
Input capacitance	C_{in}	-	50	-	pF	V = 0, f = 1KHz

Note: Reverse Voltage(VR) Condition is applied to IR test only The device is not designed for reverse operation

Output

Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
Collector-Emitter dark current	I_{CEO}	-	-	100	nA	V_{CE} = 200V, I_F=0mA
Collector-Emitter breakdown voltage	BV_{CEO}	350	-	-	V	I_c=0.1mA
Emitter-Collector breakdown voltage	BV_{ECO}	0.1	-	-	V	I_E=0.01mA

Transfer Characteristics

Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
Current Transfer ratio	CTR	1000	2000	-	%	I_F = 1mA ,V_{CE} = 2V
Collector-emitter saturation voltage	$V_{CE(sat)}$	-	1.0	1.2	V	I_F = 20mA , I_c = 100mA
Isolation resistance	R_{IO}	5×10^{10}	10^{11}	-	Ω	V_{IO} = 500Vdc, 40~60%R.H
Cut-off frequency	fc	-	7	-	KHz	V_{CE}=2V, I_C=2mA, R_L=100Ω, -3db
Floating capacitance	C_{IO}	-	0.6	-	pF	V_{IO} = 0, f = 1MHz
Rise time	t_r	-	80	250	μs	V_{CE}=2V, I_C=20mA, R_L=100Ω
Fall time	t_f	-	10	100	μs	

* Typical values at T_a = 25°C

Typical Electro-Optical Characteristics Curves

Figure 1. Forward Current vs. Forward Voltage

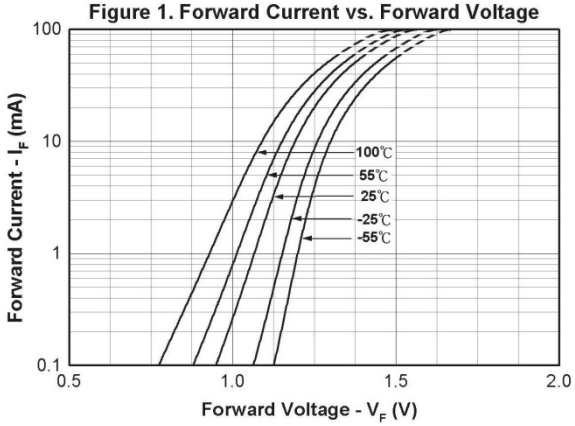


Figure 2. Collector Current vs. Collector Emitter Voltage

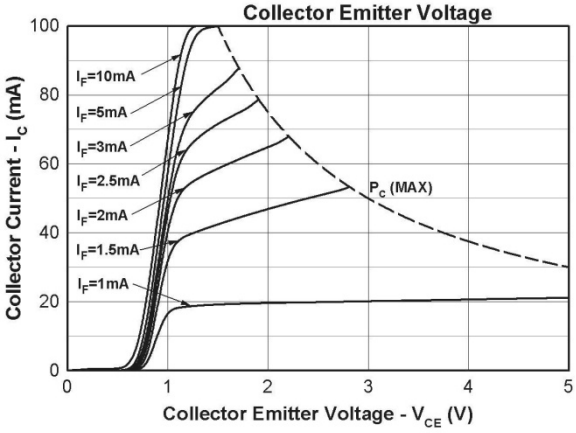


Figure 3. Collector Emitter Saturation Voltage vs. Ambient Temperature

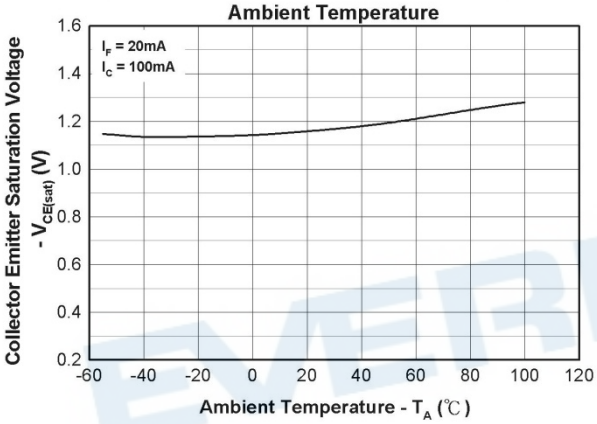


Figure 4. Collector-Emitted Saturation Voltage vs. Forward Current

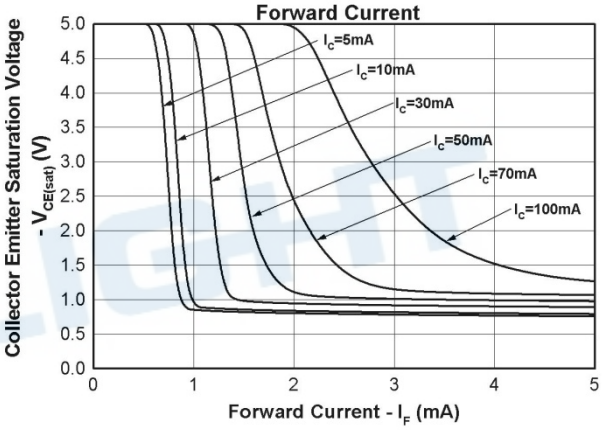


Figure 5. Current Transfer Ratio vs. Forward Current

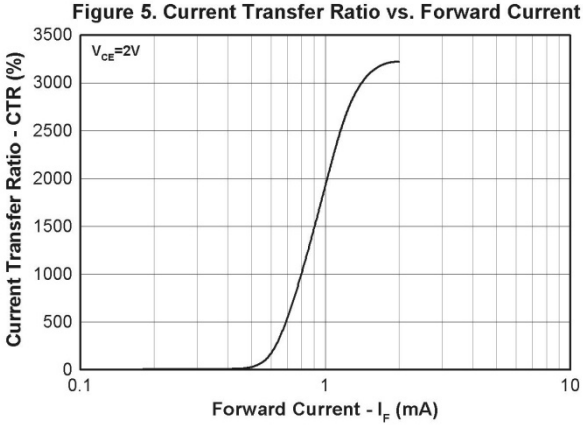


Figure 6. Normalized Current Transfer Ratio vs. Ambient Temperature

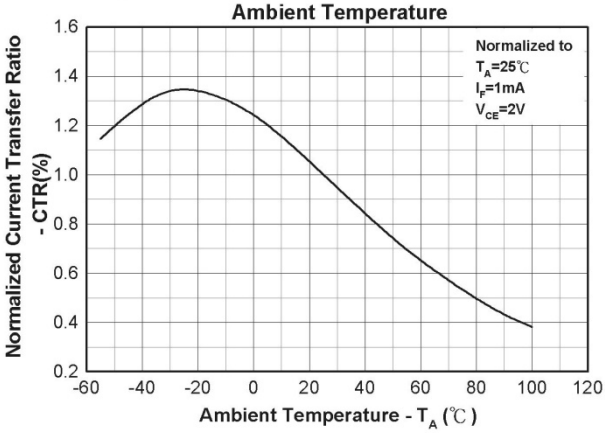


Figure 7. Collector Dark Current vs. Ambient Temperature

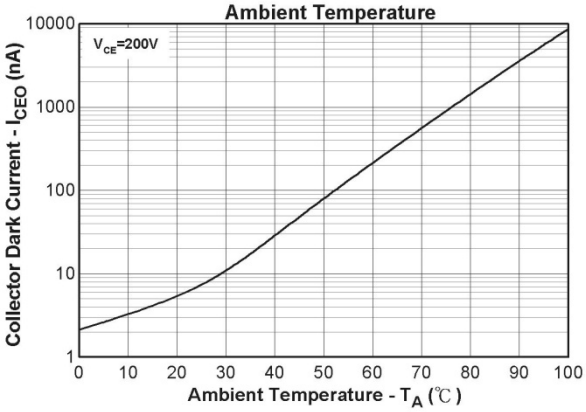


Figure 8. Response Time vs. Load Resistance

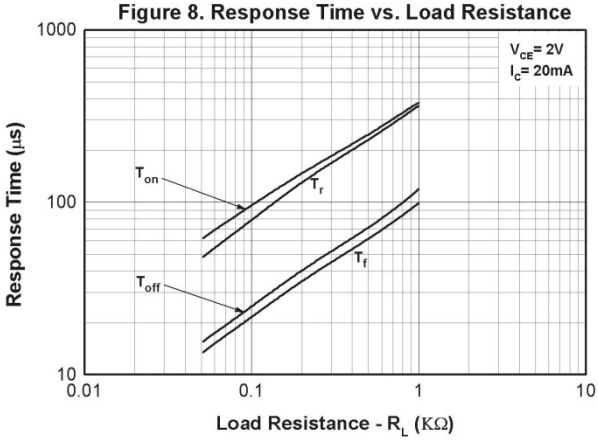
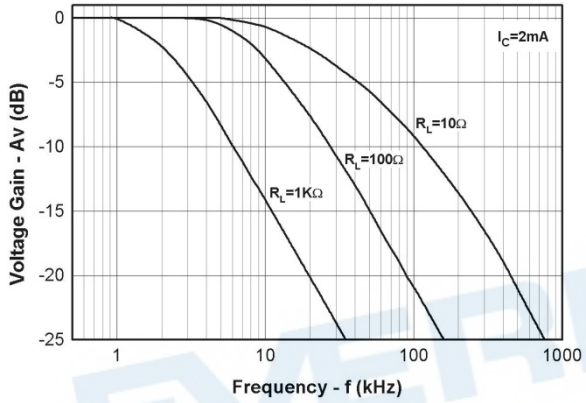


Figure 9. Frequency Response



Note：The graphs shown in this datasheet are representing typical data only and do not show guaranteed values

Order Information

Part Number

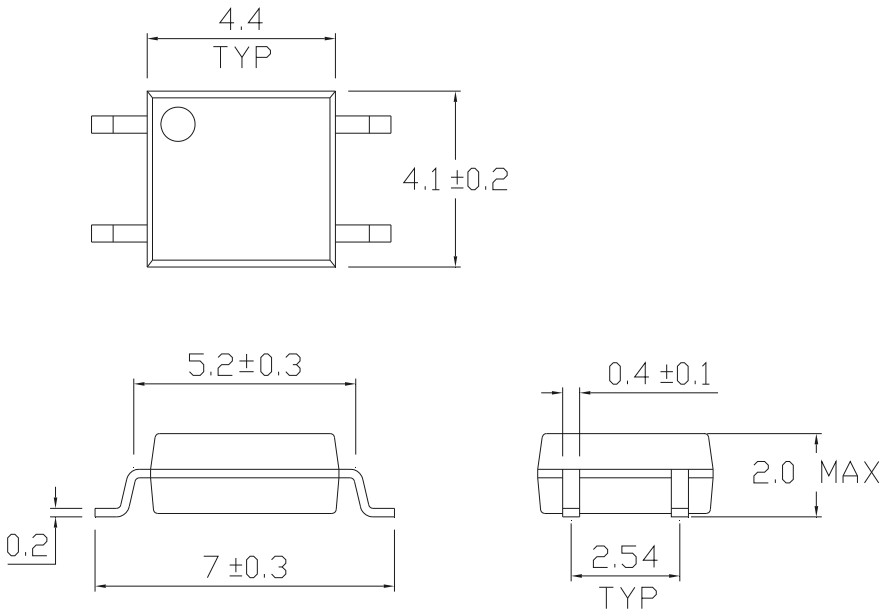
EL452(Y)-VG

Note

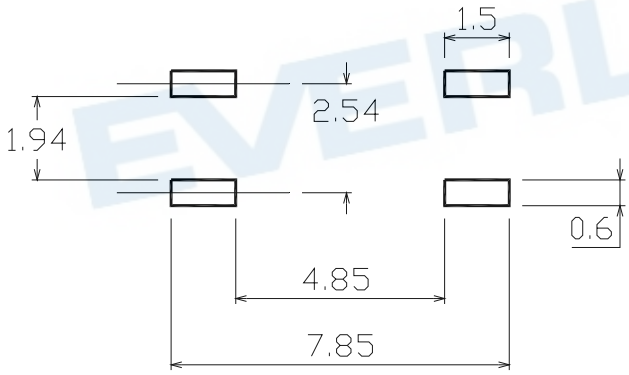
Y = Tape and reel option (TA, TB, or none).
V = VDE safety (optional)
G = Halogens free

Option	Description	Packing quantity
None	Standard SMD option	100 units per tube
-V	Standard SMD option + VDE	100 units per tube
(TA)	TA Tape & reel option	3500 units per reel
(TB)	TB Tape & reel option	3500 units per reel
(TA)-V	TA Tape & reel option + VDE	3500 units per reel
(TB)-V	TB Tape & reel option + VDE	3500 units per reel

Package Dimension (Dimensions in mm)



Recommended pad layout for surface mount leadform



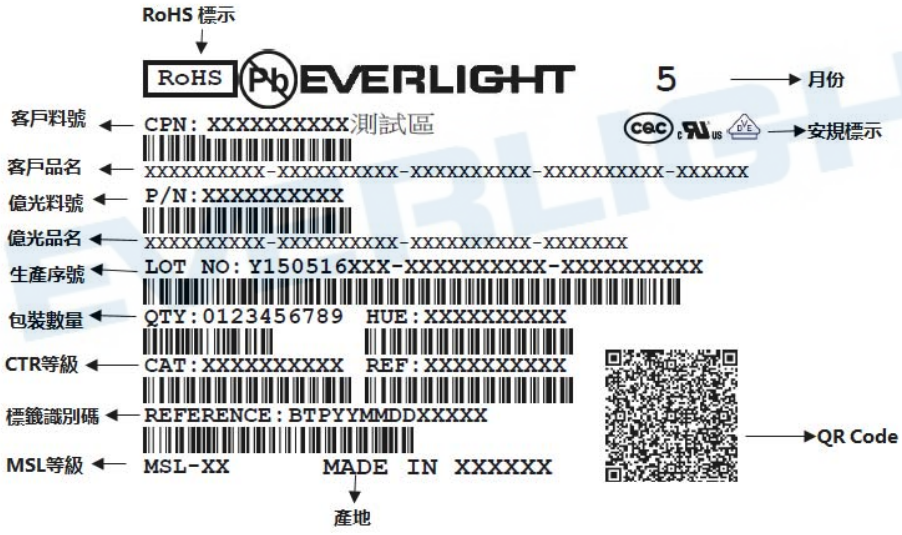
Device Marking

Notes

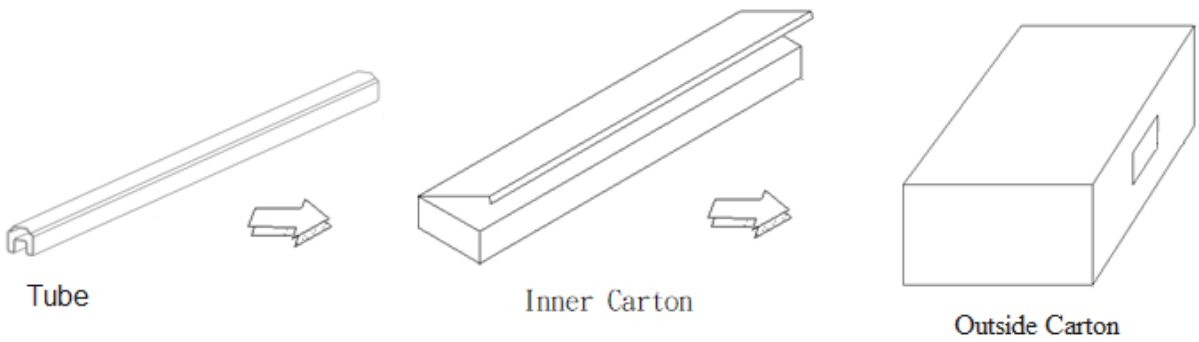
EL	denotes Everlight
452	denotes Part Number
Y	denotes 1 digit Year code
WW	denotes 2 digit Week code
V	denotes VDE approved (optional)

Label form

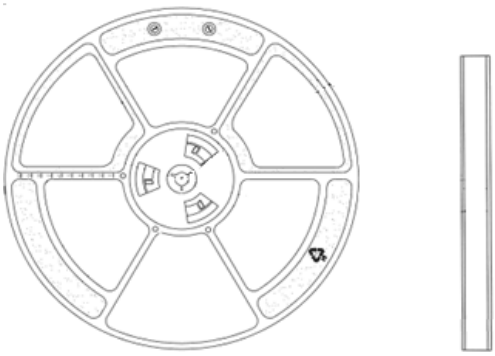
or



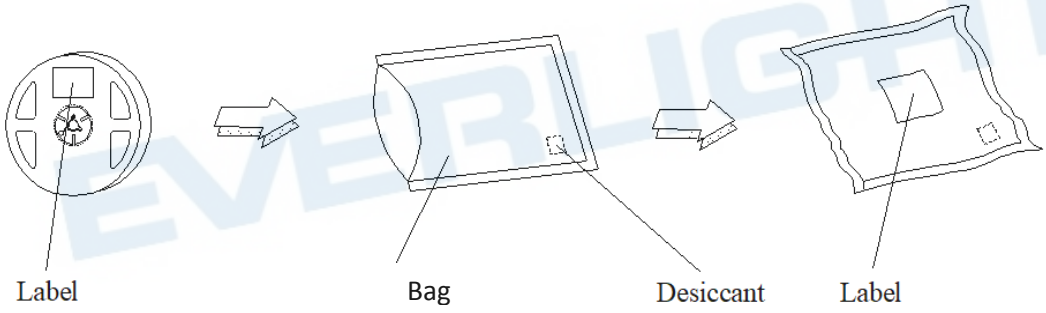
TUBE Dimension

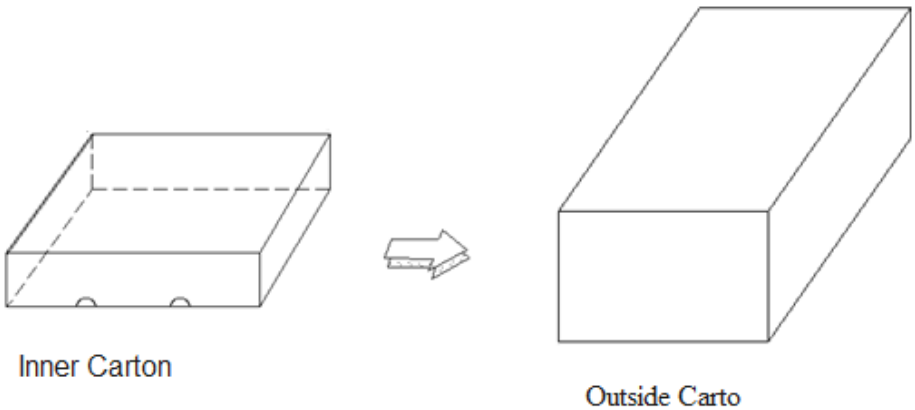


Reel Dimension



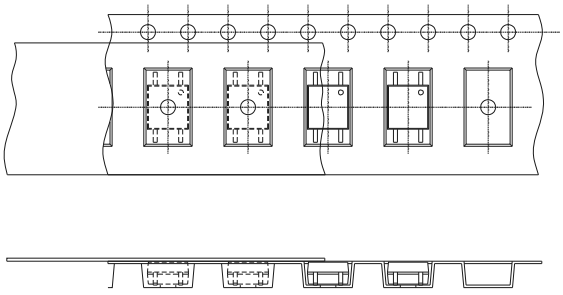
Moisture Resistant Packaging





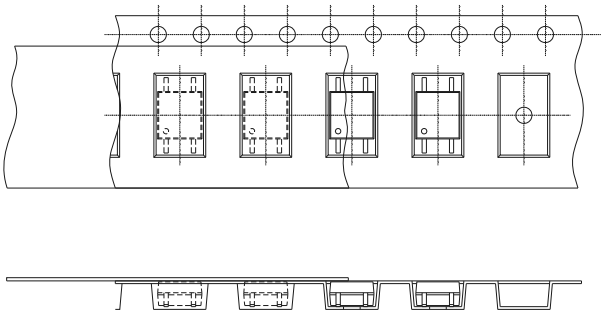
Tape & Reel Packing Specifications

Option TA



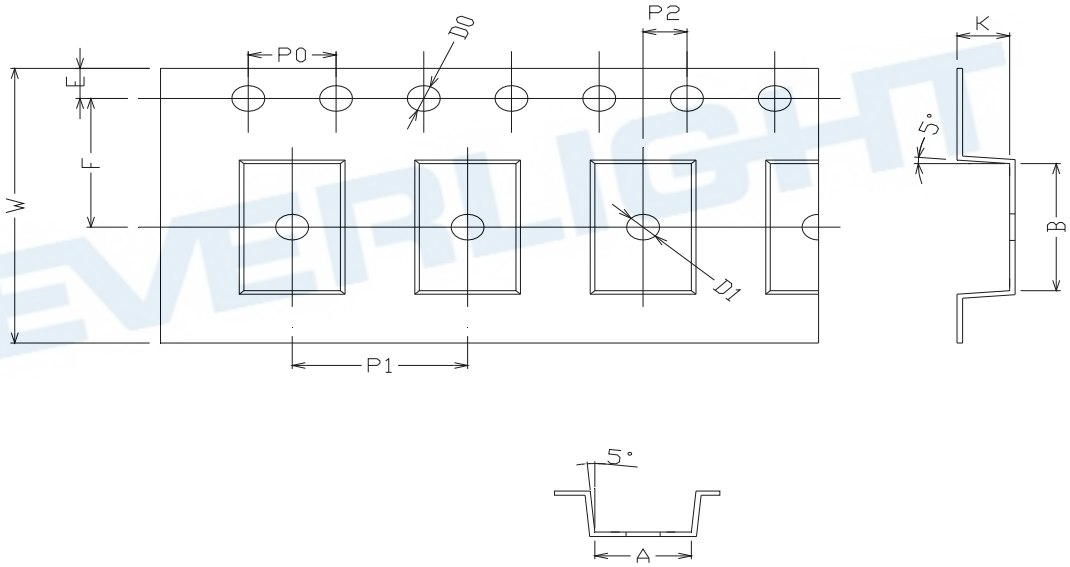
Direction of feed from reel

Option TB



Direction of feed from reel

Tape dimensions

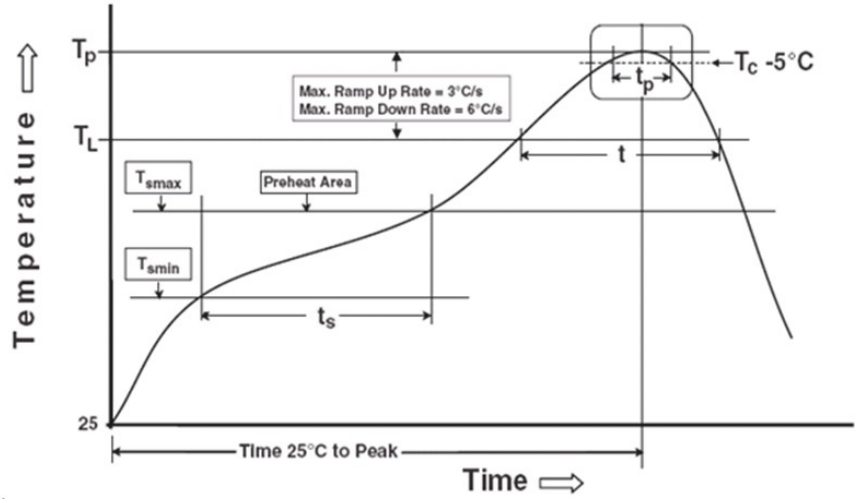


Dimension No.	A	B	Do	D1	E	F
Dimension(mm)	4.4 ± 0.1	7.4 ± 0.1	1.5 + 0.1/-0	1.5 ± 0.1	1.7 5± 0.1	7.5 ± 0.1
Dimension No.	**Po**	**P1**	**P2**	**t**	**W**	**K**
Dimension(mm)	4.0 ± 0.15	8.0 ± 0.1	2.0 ± 0.1	0.25 ± 0.03	16.0 ± 0.2	2.4 ± 0.1

Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note: Reference: IPC/JEDEC J-STD-020D

Preheat	
Temperature min (T_{smin})	150 °C
Temperature max (T_{smax})	200°C
Time (T_{smin} to T_{smax}) (t_s)	60-120 seconds
Average ramp-up rate (T_{smax} to T_p)	3 °C/second max
Other	
Liquidus Temperature (T_L)	217 °C
Time above Liquidus Temperature (t_L)	60-100 sec
Peak Temperature (T_P)	260°C
Time within 5 °C of Actual Peak Temperature: T_P - 5°C	30 s
Ramp- Down Rate from Peak Temperature	6°C /second max.
Time 25°C to peak temperature	8 minutes max.
Reflow times	3 times

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Precautions for General Storage

- Avoid storage locations where devices may be exposed to moisture or direct sunlight.
- Follow the precautions printed on the packing label of the device for transportation and storage.
- Keep the storage location temperature and humidity within a range of 5°C to 35°C and 20 % to 60 %,respectively.
- Do not store the products in locations with poisonous gases (especially corrosive gases) or in dusty conditions.
- Store the products in locations with minimal temperature fluctuations. Rapid temperature changes during storage can cause condensation, resulting in lead oxidation or corrosion, which will deteriorate the solderability of the leads.
- When restoring devices after removal from their packing, use anti-static containers.
- Do not allow loads to be applied directly to devices while they are in storage.
- If devices have been stored for more than two years under normal storage conditions, it is recommended that you check the leads for ease of soldering prior to use.

DISCLAIMER

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2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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